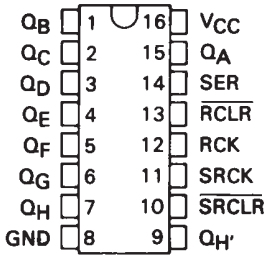
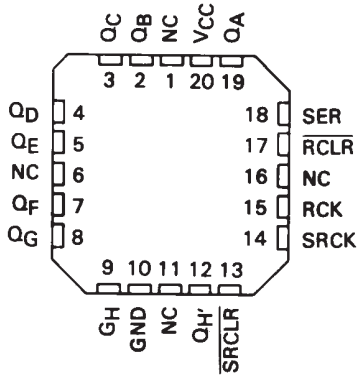
SDLS005 – D2747, JUNE 1983 – REVISED MARCH 1988

- **8-Bit Serial-In, Parallel-Out Shift Registers with Storage**
- **Choice of Output Configurations:**
  'LS594 . . . Buffered
  'LS599 . . . Open-Collector
- **Guaranteed Shift Frequency:**
  DC to 20 MHz
- **Independent Direct-Overriding Clears on Shift and Storage Registers**
- **Independent Clocks for Both Shift and Storage Registers**

SN54LS594, SN54LS599 . . . J OR W PACKAGE
SN74LS594, SN74LS599 . . . N PACKAGE
(TOP VIEW)



SN54LS594, SN54LS599 . . . FK PACKAGE
(TOP VIEW)



NC — No internal connection

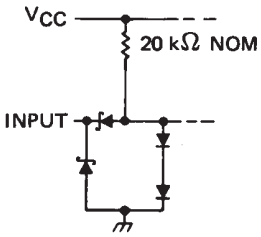
description

These devices each contain an 8-bit D-type storage register. The storage register has buffered ('LS594) or open-collector ('LS599) outputs. Separate clocks and direct-overriding clears are provided on both the shift and storage registers. A shift output (Q_H') is provided for cascading purposes.

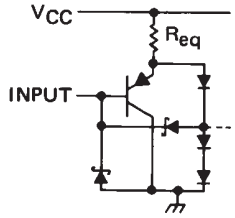
Both the shift register and the storage register clocks are positive-edge triggered. If the user wishes to connect both clocks together, the shift register will always be one clock pulse ahead of the storage register.

schematics of inputs and outputs

EQUIVALENT OF SERIAL INPUT

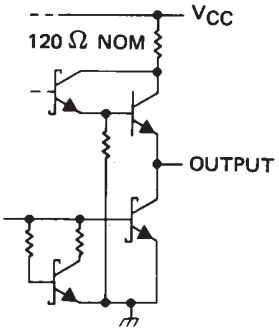


EQUIVALENT OF ALL OTHER INPUTS

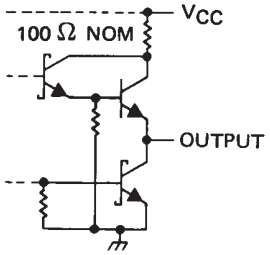


RCK, SRCK: R_{eq} = 10 kΩ NOM
ALL OTHER: R_{eq} = 13 kΩ NOM

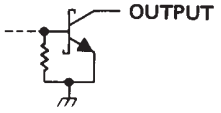
TYPICAL OF $Q_{H'}$ OUTPUTS



TYPICAL OF ALL OTHER OUTPUTS ('LS594)



TYPICAL OF ALL OTHER OUTPUTS ('LS599)



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS †		SN54LS'			SN74LS'			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN, I_I = – 18 mA				– 1.5			– 1.5	V
V_{OH}	'LS594 Q	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX	I_{OH} = – 1 mA	2.4	3.2					V
			I_{OH} = – 2.6 mA				2.4	3.1		
	Q_H'		I_{OH} = – 1 mA	2.4	3.2		2.4	3.2		
I_{OH}	'LS599 Q	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX, V_{OH} = 5.5 V				0.1			0.1	mA
V_{OL}	Q	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 24 mA					0.35	0.5	
	Q_H'		I_{OL} = 8 mA		0.25	0.4		0.25	0.4	
			I_{OL} = 16 mA					0.35	0.5	
I_I		V_{CC} = MAX, V_I = 7 V				0.1			0.1	mA
I_{IH}		V_{CC} = MAX, V_I = 2.7 V				20			20	μA
I_{IL}	SER	V_{CC} = MAX, V_I = 0.4 V				– 0.4			– 0.4	mA
	All others					– 0.2			– 0.2	
I_{OS}§	'LS594 Q	V_{CC} = MAX, V_O = 0		– 30		– 130	– 30		– 130	mA
	Q_H'			– 20		– 100	– 20		– 100	
I_{CCH}	'LS594	V_{CC} = MAX, All possible inputs grounded, All outputs open			34	50		34	50	mA
	'LS599				30	45		30	45	
I_{CCL}	'LS594				42	65		42	65	mA
	'LS599				38	55		38	55	

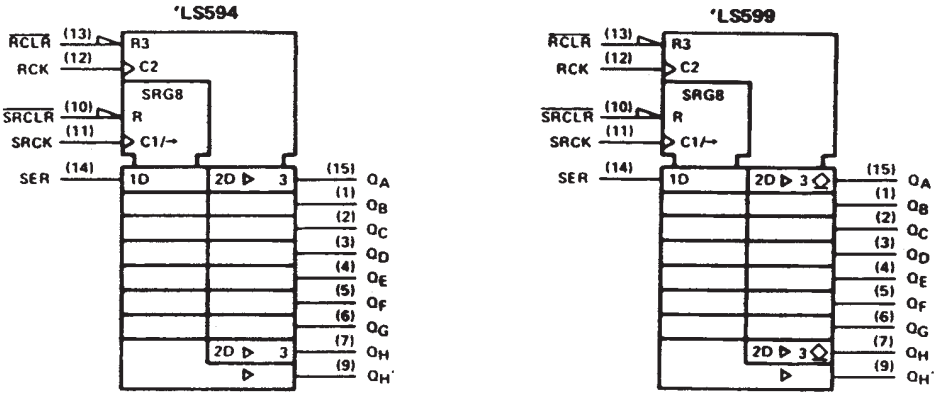
† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C, (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS594			'LS599			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
t_{PLH}	SRCK↑	Q_H'	R_L = 1 kΩ, C_L = 30 pF		12	18		12	18	ns
t_{PHL}					15	23		17	25	ns
t_{PLH}	RCK↑	Q_A thru Q_H	R_L = 667 Ω, C_L = 45 pF		12	18		28	42	ns
t_{PHL}					20	30		24	35	ns
t_{PHL}	$\overline{SRCLR}$↓	Q_H'	R_L = 1 kΩ, C_L = 30 pF		22	33		24	35	ns
t_{PHL}	$\overline{RCLR}$↓	Q_A thru Q_H	R_L = 667 Ω, C_L = 45 pF		38	57		40	60	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

logic symbols†



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Off-state output voltage . . . . . 5.5 V
Operating free-air temperature range: SN54LS594, SN54LS599 . . . . . −55°C to 125°C
SN74LS594, SN74LS599 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

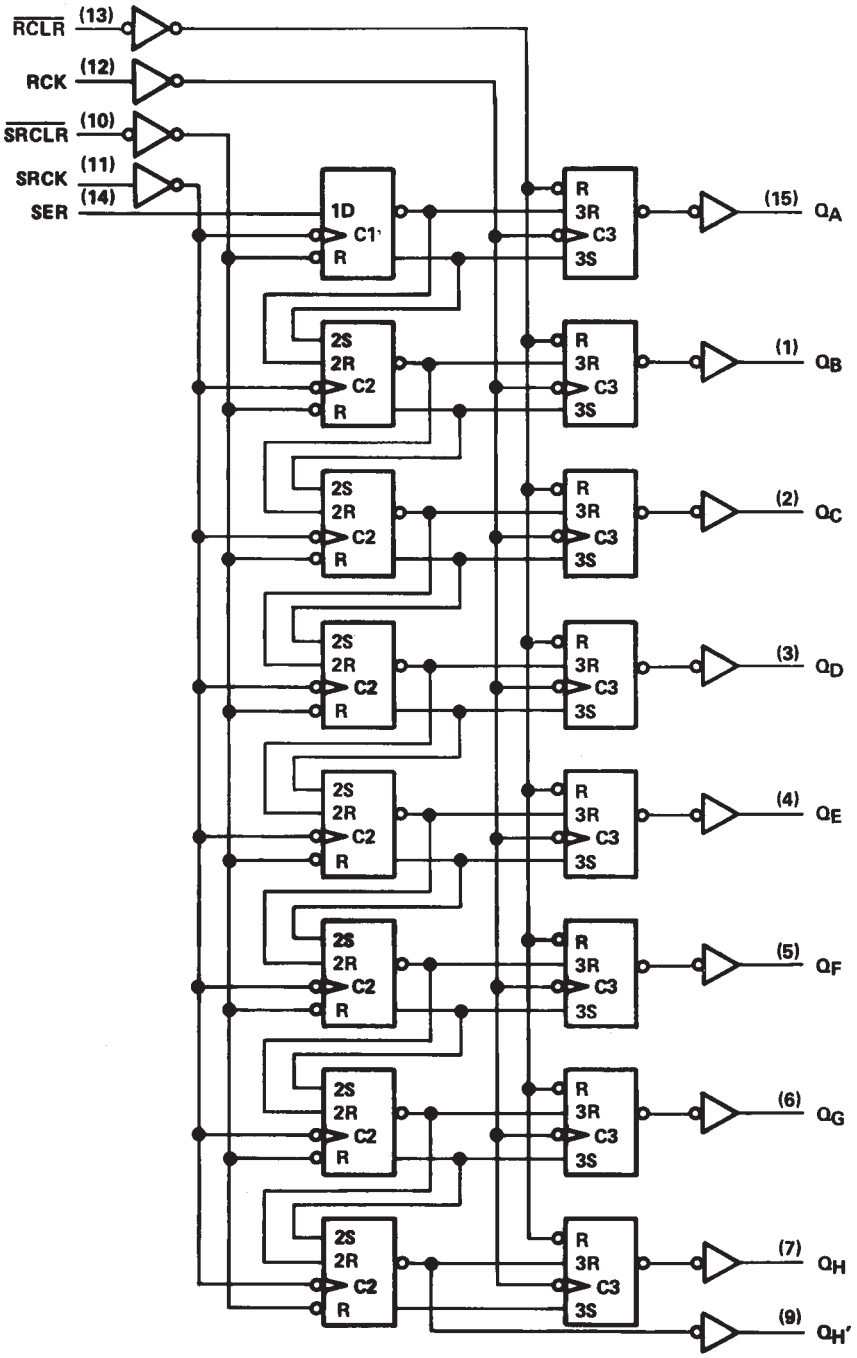
NOTE 1: Voltage values are with respect to the network ground terminal.

recommended operating conditions

			SN54LS'			SN74LS'			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
V_{OH}	High-level output voltage	Q_A thru Q_H, 'LS599 only			5.5			5.5	V
I_{OH}	High-level output current	Q_H'			−1			−1	mA
		Q_A thru Q_H, 'LS594 only			−1			−2.6	
I_{OL}	Low-level output current	Q_H'			8			16	mA
		Q			12			24	
f_{SRCK}	Shift clock frequency		0		20	0		20	MHz
f_{RCK}	Register clock frequency		0		25	0		25	MHz
$t_{w(SRCK)}$	Duration of shift clock pulse		25			25			ns
$t_{w(RCK)}$	Duration of register clock pulse		20			20			ns
$t_{w(SRCLR)}$	Duration of shift clear pulse, low level		20			20			ns
$t_{w(RCLR)}$	Duration of register clear pulse, low level		35			35			ns
t_{su}	Setup time	$\overline{SRCLR}$ inactive before SRCK↑	20			20			ns
		SER before SRCK↑	20			20			
		SRCK↑ before RCK↑ (see Note 2)	40			40			
		$\overline{SRCLR}$ low before RCK↑	40			40			
		$\overline{RCLR}$ high before RCK↑	20			20			
t_h	Hold time	SER after SRCK↑	0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

NOTE 2: This setup time ensures the register will see stable data from the shift-register outputs. The clocks may be connected together, in which case the storage register state will be one clock pulse behind the shift register.

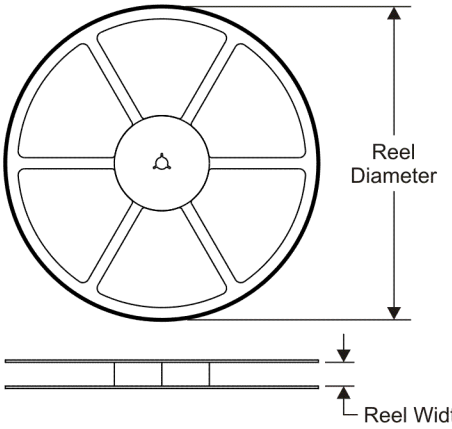
logic diagram (positive logic)



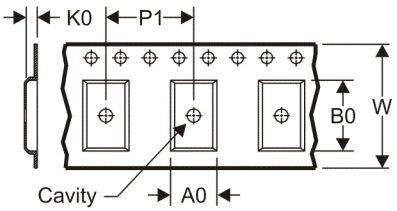
Pin numbers shown are for J, N, and W packages.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

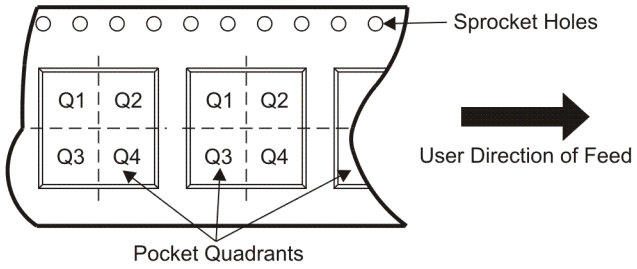


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

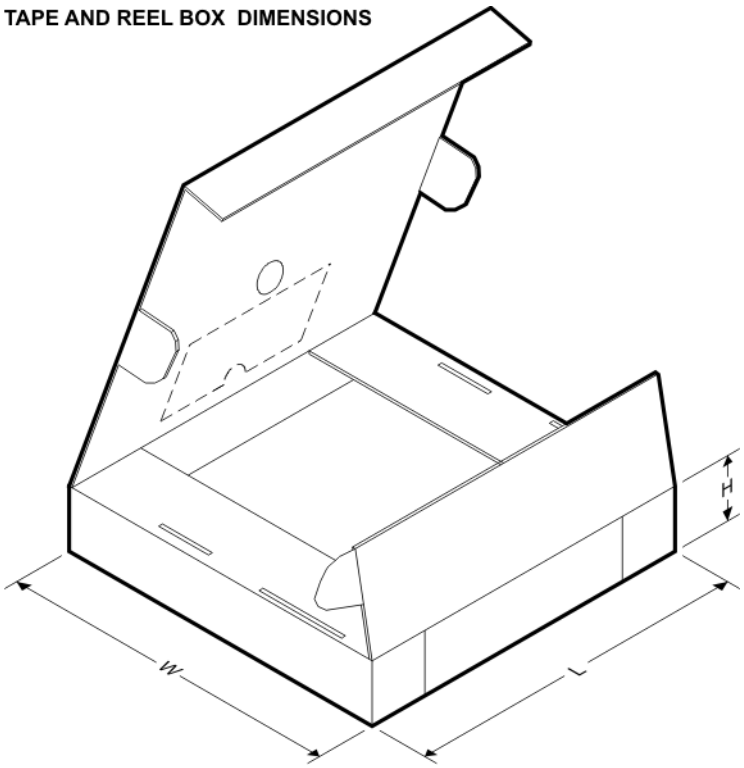
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS594NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS594NSR	SO	NS	16	2000	346.0	346.0	33.0

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74LS594N	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS594N
SN74LS594N.A	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS594N

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

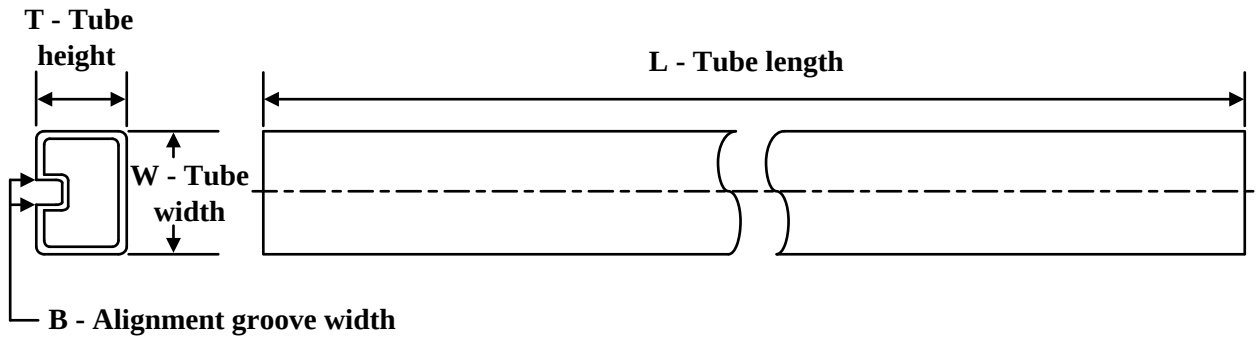
(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

TUBE



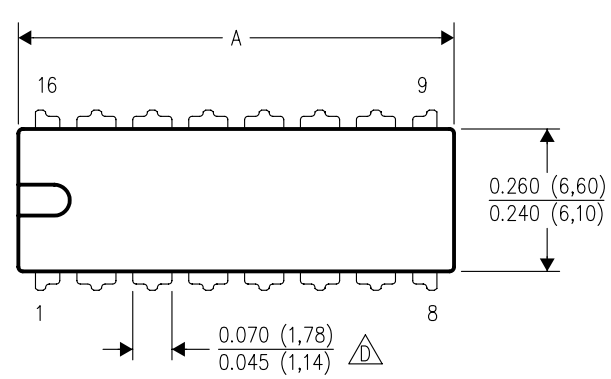
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74LS594N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS594N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS594N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS594N.A	N	PDIP	16	25	506	13.97	11230	4.32

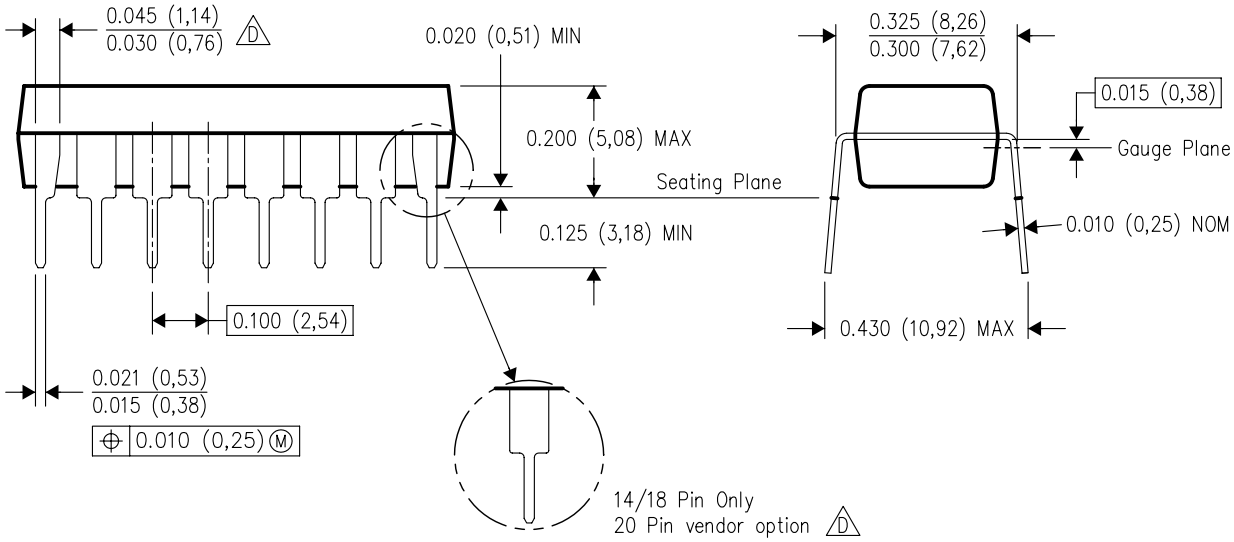
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI’s products are provided subject to TI’s Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI’s provision of these resources does not expand or otherwise alter TI’s applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265